

**INDUSTRY STANDARD OF THE
PEOPLE'S REPUBLIC OF CHINA**

SJ/T 11869-2022

**Detail specification for silicon substrate white light power light
emitting diode chip**

硅衬底白光功率发光二极管芯片详细规范

(English Translation)

Issued on: September 30, 2022

Implemented on: January 1, 2023

Issued by: Ministry of Industry and Information Technology

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What this standard covers

This standard specifies the detailed requirements for silicon substrate white light power LED chips, including chip structure, performance requirements, inspection methods, inspection rules, packaging, marking, transportation and storage, etc. It is suitable for silicon substrate white light power light emitting diode chip.

Document data

Estimated length of the Chinese original: 18,178 words.